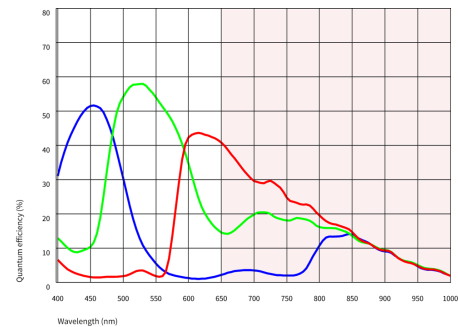


In series
The model is in series and available for the long term.



Specification

Sensor	
Sensor type	CMOS Color
Shutter	Global Shutter
Sensor characteristic	Linear
Pixel Class	12 MP
Resolution	12.42 Mpix
Resolution (h x v)	4128 x 3008 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.1"
Optical Size	11.311 mm x 8.242 mm
Optical sensor diagonal	14 mm 1/1.1"
Pixel size	2.74 μm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX545-AAQJ-C
Gain (master/RGB)	16x/16x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	2 / 2
Binning horizontal	-
Binning vertical	-
Binning method	Horizontal: addition / Vertical: addition
Binning factor	-
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	M/C automatic



Model

Frame rate freerun mode	10 fps
Frame rate trigger (continuous)	10 fps
Frame rate trigger (maximum)	10 fps
Exposure time (minimum - maximum)	0.032 ms - 2000 ms
Long exposure (maximum)	120000 ms
Line rate freerun mode (line scan)	407 1/s
Line rate trigger mode (line scan)	410 1/s
Lines per frame (line scan)	8000
Power consumption	1.9 W - 4 W
Image memory	128 MB

Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

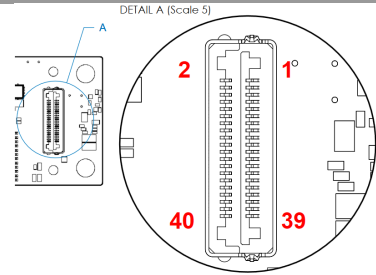
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	Samtec LSHM 40-pin
I/O connector	40-pin header (Samtec LSHM-120-L2.5-L-DV-A-S-K-TR)
Power supply	12 V - 24 V

Pin assignment I/O connector

1	Input power supply (VCC) 12-24 V DC ± 10 %
2	Do not connect (for future use)
3	Input power supply (VCC) 12-24 V DC ± 10 %
4	Do not connect (for future use)
5	Ground (GND)
6	Do not connect (for future use)
7	Flash output without optocoupler 3.15 V 8 mA
8	Do not connect (for future use)
9	Trigger input without optocoupler 3.15 V
10	Ground (GND)
11	Do not connect (for future use)
12	Ground (GND)
13	Do not connect (for future use)
14	Do not connect (for future use)
15	I2C SDA (signal data) 3.15 V
16	Do not connect (for future use)
17	I2C SCL (signal clock) 3.15 V
18	Do not connect (for future use)
19	Do not connect (for future use)
20	RJ45 MX0 (-)
21	Do not connect (for future use)
22	RJ45 MX0 (+)
23	General Purpose I/O (GPIO) 2, 3.15 V 8 mA
24	Do not connect (for future use)
25	General Purpose I/O (GPIO) 1, 3.15 V 8 mA
26	RJ45 MX1 (-)
27	Ethernet, LED green, output 3.15 V
28	RJ45 MX1 (+)
29	Power, LED green, output 3.15 V
30	Do not connect (for future use)
31	Power, LED red, output 3.15 V
32	RJ45 MX2 (+)
33	Ethernet, LED red, output 3.15 V
34	RJ45 MX2 (-)
35	Do not connect (for future use)
36	Do not connect (for future use)
37	Do not connect (for future use)
38	RJ45 MX3 (+)
39	Ground (GND)
40	RJ45 MX3 (-)



Design

Lens Mount	C-Mount
IP code	-
Dimensions H/W/L	84.0 mm x 40.0 mm x 29.7 mm
Mass	34 g
Housing material	-

Features

List of on-camera image pre-processing features.
All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

GV-51L1ACP-C-HQ Rev.1.2 (1009805)

Image Acquisition	Freerun	✓
	Software trigger	✓
	Hardware trigger	✓
	Trigger controlled exposure	✓
	Denoiser	✓
	Long exposure	✓
	Line scan	✓
Flashing	Flashing	✓
	PWM flashing	✓
Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	✓
	Color correction	✓
	Gamma	✓
	LUT	✓
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8
		BayerRG8
		BayerRG10
		BayerRG10p
		BayerRG12
		BayerRG12p
		BGR8
		RGB8
		BGR10p32
		RGB10p32
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	
	Binning (FPGA)	✓
Others		Binning (Sensor)
		IP settings
		Bandwidth management
		Chunks
		Sequencer
		PTP
		Firmware update
		1st supported firmware version
		3.31